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Docket No.: GR 98 P 1075 P

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By: [Signature]

Date: June 24, 2002

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Manfred Fries et al.  
Applic. No. : 09/627,181  
Filed : July 27, 2000  
Title : Chip Smart Card Module for Biometric Sensors  
Art Unit : 2721

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INFORMATION DISCLOSURE STATEMENT

Hon. Commissioner of Patents and Trademarks,  
Washington, D.C. 20231

Sir:

In accordance with 37 C.F.R. 1.98 copies of the following patents and/or publications are submitted herewith:

United States Patent No. 5,862,248 (Salatino et al.), dated January 19, 1999.

Respectfully submitted,

[Signature]  
For Applicants

Mark P. Weichselbaum  
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Date: June 24, 2002

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